



DFLZ5V1 - DFLZ39

1.0W SURFACE MOUNT POWER ZENER DIODE POWERDI[®]123

Features

- 1W Power Dissipation on FR-4 PCB
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- Patented Interlocking Clip Design for High Surge Capacity, US Patent #7,095,113

Mechanical Data

- Case: POWERDI123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.01 grams (approximate)



Top View

Ordering Information (Note 4)

| Part Number | Qualification | Case | Packaging |
|-------------------|---------------|--------------------------|------------------|
| (Type Number)-7* | Commercial | POWERDI [®] 123 | 3000/Tape & Reel |
| (Type Number)Q-7* | Automotive | POWERDI [®] 123 | 3000/Tape & Reel |

* Add "-7" to the appropriate type number in Electrical Characteristics Table. Example: 6.2V Zener = DFLZ6V2-7

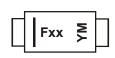
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



Fxx = Product Type Marking Code (See Electrical Characteristics Table) YM = Date Code Marking Y = Year (ex: A = 2013) M = Month (ex: 9 = September)

Notes:

| Year | 2007 | 200 | 8 20 | 09 2 | 010 | 2011 | 2012 | 2013 | 2014 | 2015 | 2016 | 2017 | 2018 |
|------|------|-----|------|------|-----|------|------|------|------|------|------|------|------|
| Code | U | V | , | N | Х | Y | Z | А | В | С | D | Е | F |
| Mon | th | Jan | Feb | Mar | Apr | Мау | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Cod | е | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | Ν | D |

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit |
|-----------------|--------------------------|----------------|-------|------|
| Forward Voltage |) I _F = 200mA | V _F | 1.2 | V |

Thermal Characteristics

| Characteristic | Symbol | Тур | Value | Unit |
|---|----------------------|-----|-------------|------|
| Power Dissipation (Note 5) | PD | _ | 1.0 | W |
| Thermal Resistance Junction to Ambient Air (Note 5) | R ₀ JA | 110 | _ | °C/W |
| Thermal Resistance Junction to Soldering Point (Note 6) | R _{0JS} | — | 9 | °C/W |
| Operating and Storage Temperature Range | TJ, T _{STG} | — | -55 to +150 | °C |

Maximum Reverse Temperature Zener Voltage Range **Zener Impedance** Current Coefficient (Note 7) Туре Marking (Note 7) @ I_{ZTC} Number Codes Vz@Izt IZT Z_{ZT} @ I_{ZT} I_R @ V_R %/°C Nom (V) Min (V) Max (V) mA Typ (Ω) Max (Ω) μA ۷ Min Max DFLZ5V1 FHK 5.1 4.8 5.4 100 6 2.5 1 -0.08 -0.2 DFLZ5V6 FHL 5.6 6.0 100 10 2 -0.04 0.04 5.2 1 4 DFLZ6V2 FHN 6.2 5.8 6.6 100 3 2 -0.01 0.06 1 5 DFLZ6V8 FHO 6.8 6.4 7.2 100 1 3 5 3 0.07 0 DFLZ7V5 FHQ 7.5 7.0 7.9 100 1 2 5 3 0 0.07 7.7 DFLZ8V2 FHR 8.2 8.7 100 1 2 5 3 0.03 0.08 DFLZ9V1 FHT 8.5 9.6 50 5 0.03 0.08 9.1 1 4 5 DFLZ10 FHU 10.6 50 4 0.05 10 9.4 1 5 7.5 0.09 DFLZ11 FHV 11 10.4 11.6 50 1 7 4 8.2 0.05 0.10 DFLZ12 FHW 7 12 12.7 50 1 3 9.1 0.05 11.4 0.10 DFLZ13 13 12.4 14.1 50 10 2 0.05 FHX 1 10 0.10 DFLZ15 FHZ 15 50 0.05 13.8 15.6 1 10 1 11 0.10 DFLZ16 FJA 16 15.3 17.1 25 1 15 1 12 0.06 0.11 DFLZ18 FJF 18 16.8 19.1 25 2 15 1 13 0.06 0.11 20 15 DFLZ20 FJG 18.8 21.2 25 3 15 1 0.06 0.11 DFLZ22 FJK 22 20.8 23.3 25 3 15 16 0.06 0.11 1 DFLZ24 FJL 24 22.8 25.6 25 2 15 18 0.06 0.11 1 DFLZ27 FJN 27 25.1 28.9 25 3 15 1 20 0.06 0.11 DFLZ30 25 30 FJQ 15 28 32 8 1 22 0.06 0.11 DFLZ33 FJR 33 31 35 25 15 1 24 0.06 0.11 5 DFLZ36 FJS 36 34 38 10 5 40 27 0.06 0.11 1 DFLZ39 FJT 39 37 41 10 5 40 1 30 0.06 0.11

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

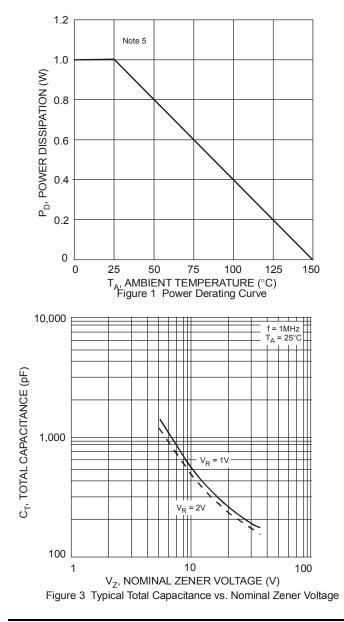
Notes: 5. Device mounted on 1" x 1", FR-4 PCB; 2 oz. Cu pad layout as shown on Diodes Inc. suggested pad layout document AP02001.pdf at http://www.diodes.com.

6 Theoretical R_{0JS} calculated from the top center of the die straight down to the PCB/cathode tab solder junction.

7. Short duration pulse test used to minimize self-heating effect.

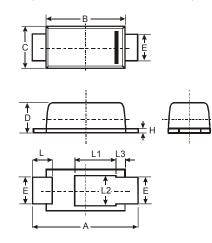


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Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| POWERDI [®] 123 | | | | | | | |
|--------------------------|----------------------|------|------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| Α | 3.50 | 3.90 | 3.70 | | | | |
| в | 2.60 | 3.00 | 2.80 | | | | |
| C | 1.63 | 1.93 | 1.78 | | | | |
| D | 0.93 | 1.00 | 0.98 | | | | |
| Е | 0.85 | 1.25 | 1.00 | | | | |
| H | 0.15 | 0.25 | 0.20 | | | | |
| 1 | 0.40 | 0.50 | 0.45 | | | | |
| L1 | - | - | 1.35 | | | | |
| L2 | - | - | 1.10 | | | | |
| L3 | - | - | 0.20 | | | | |
| All D | All Dimensions in mm | | | | | | |

1

0.1

0.01

0.001

0.0001

0.00001

0.000001

0.5

0.6

0.7

V_F, INSTANTANEOUS FORWARD VOLTAGE (V) Figure 2 Typical Forward Characteristics

0.8

0.9

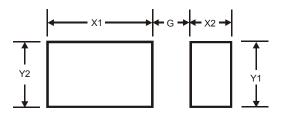
I_F, INSTANTANEOUS FORWARD CURRENT (A)

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Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| G | 1.0 |
| X1 | 2.2 |
| X2 | 0.9 |
| Y1 | 1.4 |
| Y2 | 1.4 |

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